



AP2204

WIDE INPUT VOLTAGE RANGE, 150mA ULDO REGULATOR

Description

The AP2204 series is a positive voltage regulator IC fabricated by high voltage EPNP process.

The AP2204 has features of wide input voltage range, high accuracy, high ripple rejection, low dropout voltage, low noise, current limit and ultra-low quiescent current which make it ideal for use in various USB and portable devices.

The IC consists of a voltage reference, an error amplifier, a resistor network for setting output voltage, a current limit circuit for current protection, and a chip enable circuit.

The AP2204 has 1.5V, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V, 5.0V fixed voltage versions and adjustable voltage version.

The AP2204 is available in space-saving SOT-23-5, SOT-89 and PSOP-8 packages.

Features

- Wide Input Voltage Range: 2.3V to 24V
- Wide Output Voltage Range: 1.24V to 22V
- Excellent Ripple Rejection: 60dB@ f = 1kHz
- Low Dropout Voltage: V_{DROP} = 100mV@ I_{OUT} = 100μA
- Low Ground Current
- High Output Voltage Accuracy
- Compatible with Low ESR Ceramic Capacitor
- Excellent Line/Load Regulation
- Thermal Shutdown Function
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

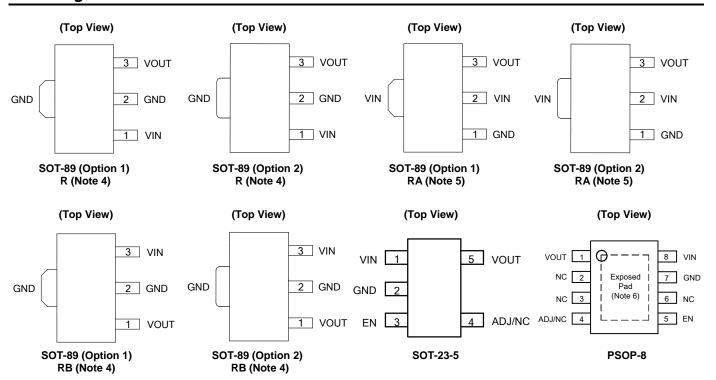
Applications

- Battery-powered Equipment
- Laptop, Palmtops, Notebook Computers
- Portable Information Appliances

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments

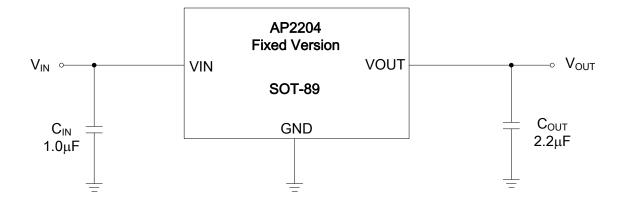


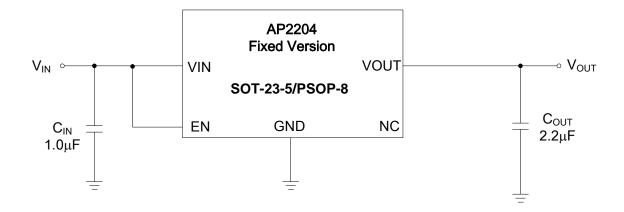
Notes:

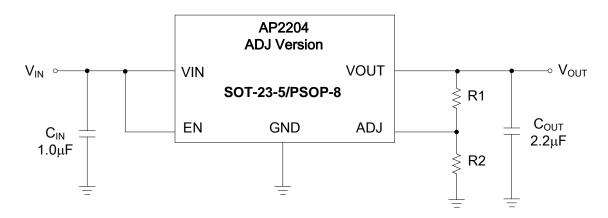
- 4. The substrate/exposed pad should be connected to GND or open.
- 5. The substrate/exposed pad should be connected to VIN or open.
- 6. The exposed pad should be connected to GND for better dissipation.



Typical Applications Circuit







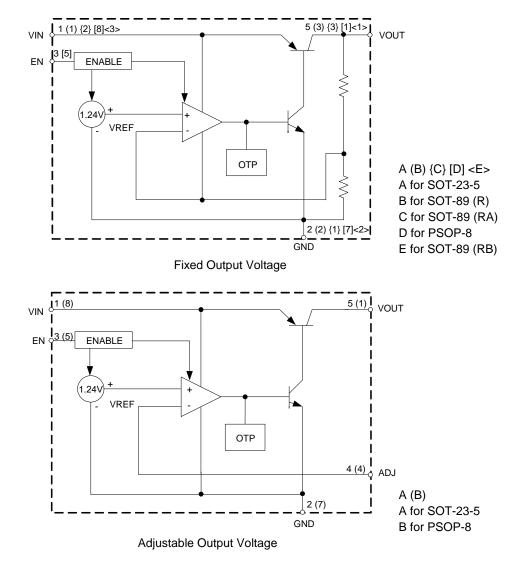
 $V_{OUT}=V_{REF}(1+(R1/R2))$



Pin Descriptions

	Р	in Number						
227.22.5			SOT-89		Pin Name	Function		
SOT-23-5	PSOP-8	R	RA	RB				
1	8	1	2	3	VIN	Input voltage		
2	7	2	1	2	GND	Ground		
3	5	-	_	-	EN	Enable input		
4	4	-	_	-	ADJ/NC	Adjust output for ADJ version/No connected for fixed version		
5	1	3	3	1	VOUT	Regulated output voltage		

Functional Block Diagram





Absolute Maximum Ratings (Note 7)

Symbol	Parameter	Rati	Unit	
V _{IN}	Supply Input Voltage	38	V	
V_{CE}	Enable Input Voltage	38	3	V
I _{OUT}	Output Current	25	0	mA
T _{LEAD}	Lead Temperature (Soldering, 10sec) +260		°C	
TJ	Operating Junction Temperature	+150		°C
		SOT-23-5	250	
$\theta_{\sf JA}$	Thermal Resistance	SOT-89	165	°C/W
		PSOP-8 (Note 8)	51	
T _{STG}	Storage Temperature Range	-65 to +150		°C
-	ESD (Machine Model)	275		V
	ESD (Human Body Model)	2000		V

Notes:

- 7. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.
- 8. θ_{JA} is measured with the component mounted on a 2-Layer FR-4 PCB board with 1.5cm*1.5cm thermal sink pad in free air.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{IN}	Supply Input Voltage	2.3	24	V
TJ	Operating Junction Temperature	-40	+125	°C



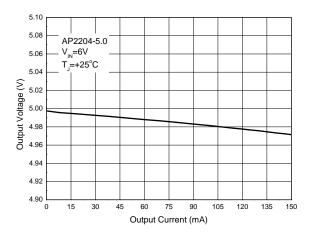
Electrical Characteristics (@V_{IN} = V_{OUT}+1V, T_J = +25°C, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, **Bold** typeface applies over - 40°C \leq T_J \leq +125°C, unless otherwise specified.)

Symbol	Parameter	Conc	litions	Min	Тур	Max	Unit
Vouт	Output Voltage	Variation from Specified V _{OUT}		V _{ОUТ} ×98%	_	V _{OUT} ×102%	V
V_{REF}	Reference Voltage	_		1.215	1.24	1.265	V
VIN	Input Voltage	_		_	ı	24	V
I _{OUT(max)}	Maximum Output Current	V _{IN} -V _{OUT} = 1V, V _{OUT} = 98% × V _{OUT}		150	200	-	mA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$V_{OUT}+1V \le V_{IN} \le 2$	24V	_	0.05	-	%
ΔV _{OUT} /V _{OUT}	Load Regulation	1mA ≤ I _{OUT} ≤ 150mA		_	0.5	_	%
		I _{OUT} = 100μA		_	100	150	
		I _{OUT} = 50mA		_	270	350	
V_{DROP}	Dropout Voltage	I _{OUT} = 100mA		_	320	460	mV
		I _{OUT} = 150mA		_	360	500	
		I _{OUT} = 0A		_	20	_	
		I _{OUT} = 100μA	_	50	-	μΑ	
I _{GND}	Ground Current	I _{OUT} = 50mA	_	0.5	_	mA	
IGND		I _{OUT} = 100mA	_	1.3	_		
		I _{OUT} = 150mA I _{OUT} = 0A I _{OUT} = 100μA I _{OUT} = 50mA I _{OUT} = 150mA I _{OUT} = 150mA V _{IN} = V _{OUT} +1V V _{EN} in OFF Mode Ripple 0.5V _{P-P} V _{IN} = V _{OUT} +1V f = 100μA,		_	2.5	-	
I _{STD}	Standby Current	V _{IN} = V _{OUT} +1V		-	0.01	1.0	μΑ
5055		Ripple 0.5V _{P-P}	f = 100Hz	_	60	-	į
PSRR	Power Supply Rejection Ration	• •	f = 1kHz	_	60	_	dB
$\Delta V_{OUT}/(V_{OUT} \times \Delta T)$	Output Voltage Temperature Coefficient		°C	-	±100	_	ppm/°C
V _{NOI}	RMS Output Noise	T _J = +25°C, 10Hz	≤ f ≤ 100kHz	_	30	_	μV_{rms}
l _{ADJ}	ADJ Pin Current	I _{OUT} = 100μA		_	0.5	_	μΑ
I _{EN}	EN Pin Current	V _{EN} = V _{OUT} +1V		_	1	-	μΑ
_	EN "High" Voltage	EN Input Voltage "High"		2.0	-	_	V
-	EN "Low" Voltage	EN Input Voltage	"Low"	_	-	0.4	V
		SOT-23-5	-	43	_		
θјС	Thermal Resistance	SOT-89	-	27	_	°C/W	
	Maximum Output Current V _{IN-} V _{OUT} = 1V, V _{OUT} = 98% × V _{OUT} 150 200 N	_					

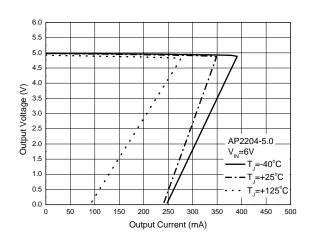


Performance Characteristics

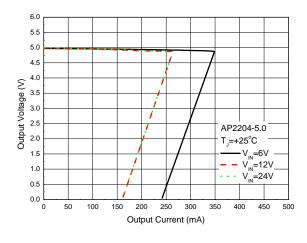
Output Voltage vs. Output Current



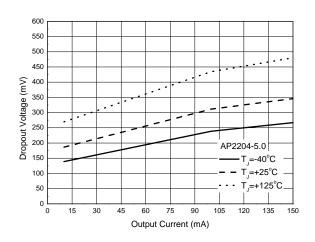
Output Voltage vs. Output Current



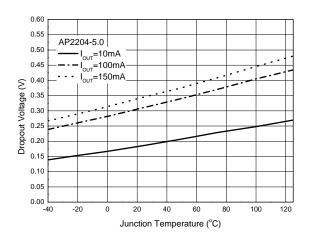
Output Voltage vs. Output Current



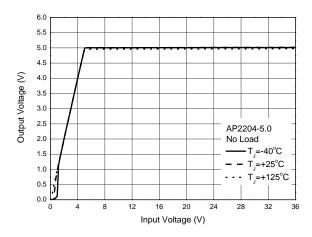
Dropout Voltage vs. Output Current



Dropout Voltage vs. Junction Temperature



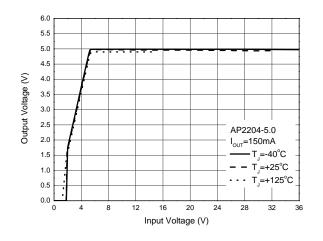
Output Voltage vs. Input Voltage



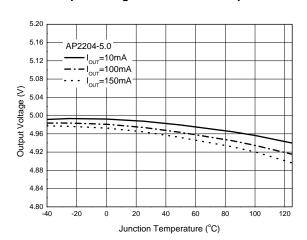


Performance Characteristics (Cont.)

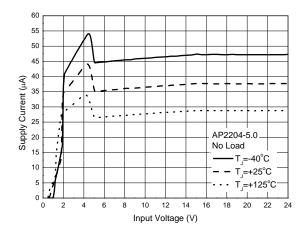
Output Voltage vs. Input Voltage



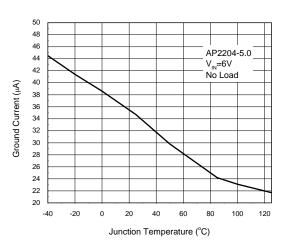
Output Voltage vs. Junction Temperature



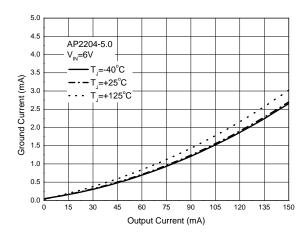
Supply Current vs. Input Voltage



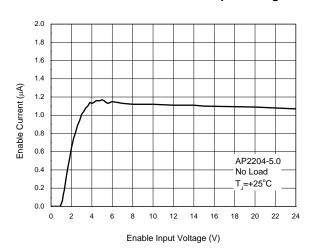
Ground Current vs. Junction Temperature



Ground Current vs. Output Current

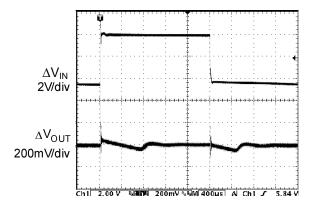


Enable Current vs. Enable Input Voltage

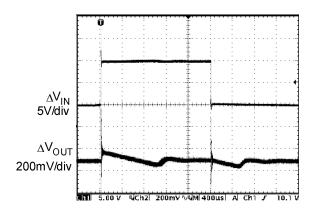


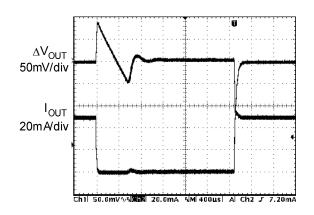


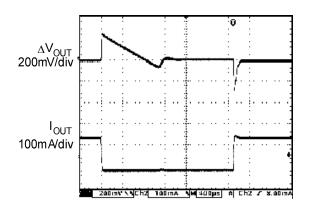
Performance Characteristics (Cont.)



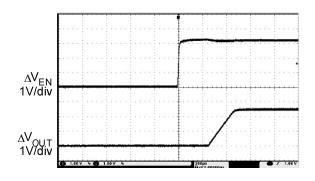
 $\label{eq:line_line} Line Transient $$ (Conditions: V_{IN}=V_{EN}=5V$ to 15V, $C_{IN}=1.0\mu F, $C_{OUT}=2.2\mu F, I_{OUT}=1mA)$$$



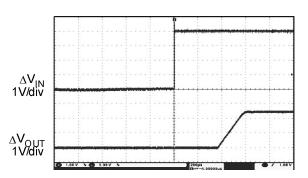




Enable Input Response



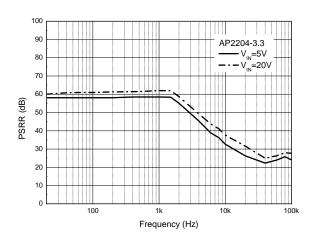
Start-up Response



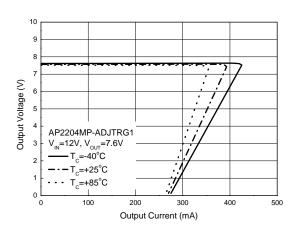


Performance Characteristics (Cont.)

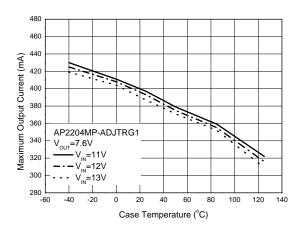
PSRR vs. Frequency (Conditions: V_{PP}=2V, I_{OUT}=10mA)



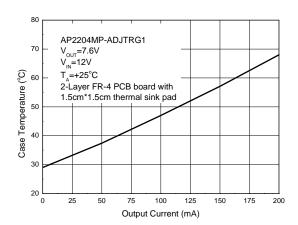
Output Voltage vs. Output Current



Maximum Output Current vs. Case Temperature

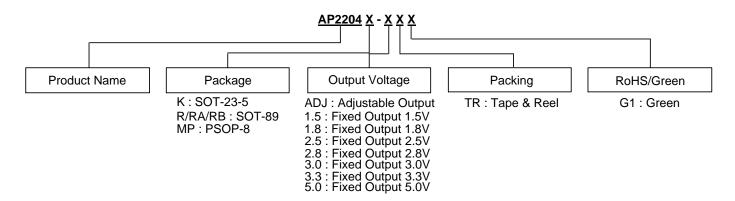


Case Temperature vs. Output Current





Ordering Information



Package	Temperature Range	Output Voltage	Part Number	Marking ID	Packing
		ADJ	AP2204K-ADJTRG1	GAF	3000/7" Tape & Reel
		1.5V	AP2204K-1.5TRG1	GBH	3000/7" Tape & Reel
		1.8V	AP2204K-1.8TRG1	GAG	3000/7" Tape & Reel
007.00.5	40.45 - 05.00	2.5V	AP2204K-2.5TRG1	GAD	3000/7" Tape & Reel
SOT-23-5	-40 to +85°C	1.5V AP2204K-1.5TRG1 GBH 1.8V AP2204K-1.8TRG1 GAG 2.5V AP2204K-2.5TRG1 GAD 3.0V AP2204K-3.0TRG1 GEF 3.3V AP2204K-3.3TRG1 GAH 5.0V AP2204K-5.0TRG1 GAI 1.5V (R) AP2204R-1.5TRG1 G22C 1.8V (R) AP2204R-1.8TRG1 G31C 1.5V (R) AP2204R-2.5TRG1 G22D 1.8V (R) AP2204R-2.5TRG1 G22E 3.0V (R) AP2204R-3.0TRG1 G22E 1.8V (R) AP2204R-3.0TRG1 G22E 1.8V (R) AP2204R-3.0TRG1 G22E 3.0V (R) AP2204R-3.0TRG1 G22E 3.0V (R) AP2204R-3.0TRG1 G31D 5.0V (R) AP2204R-3.3TRG1 G31D	3000/7" Tape & Reel		
		3.0V	AP2204K-3.0TRG1	GEF	3000/7" Tape & Reel
		3.3V	AP2204K-3.3TRG1	GAH	3000/7" Tape & Reel
		5.0V	AP2204K-5.0TRG1	GAI	3000/7" Tape & Reel
		1.5V (R)	AP2204R-1.5TRG1	G22C	1000/7" Tape & Reel
		1.8V (R)	AP2204R-1.8TRG1	G31C	1000/7" Tape & Reel
		2.5V (R)	AP2204R-2.5TRG1	G22D	1000/7" Tape & Reel
SOT-89	-40 to +85°C	2.8V (R)	AP2204R-2.8TRG1	G22E	1000/7" Tape & Reel
		3.0V (R)	AP2204R-3.0TRG1	G22F	1000/7" Tape & Reel
		3.3V (R)	AP2204R-3.3TRG1	G31D	1000/7" Tape & Reel
		5.0V (R)	AP2204R-5.0TRG1	G31E	1000/7" Tape & Reel
007.00	40.15 . 05.00	3.3V (RA)	AP2204RA-3.3TRG1	G37O	1000/7" Tape & Reel
SOT-89	-40 to +85°C	5.0V (RA)	AP2204RA-5.0TRG1	G410	1000/7" Tape & Reel
COT 00	40.45 : 05.00	3.3V (RB)	AP2204RB-3.3TRG1	G37R	1000/7" Tape & Reel
SOT-89	-40 to +85°C	5.0V (RB)	AP2204RB-5.0TRG1	G41R	1000/7" Tape & Reel
PSOP-8	-40 to +85°C	ADJ	AP2204MP-ADJTRG1	2204MP-ADJG1	4000/13" Tape & Reel



Marking Information

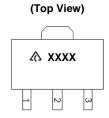
(1) SOT-23-5



A: Logo

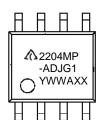
XXX: Marking ID (See Ordering Information)

(2) SOT-89



First Line: Logo and Marking ID (See Ordering Information)

(3) PSOP-8



(Top View)

First and Second Lines: Logo and Marking ID

(See Ordering Information) Third Line: Date Code

Y: Year

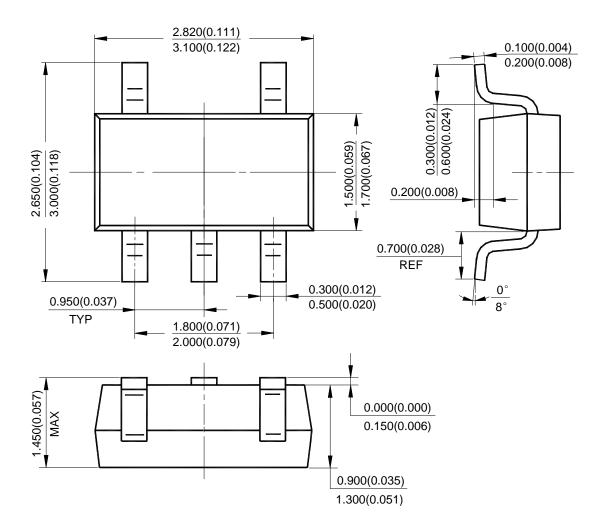
WW: Work Week of Molding

A: Assembly House Code XX: 7th and 8th Digits of Batch Number



Package Outline Dimensions (All dimensions in mm(inch).)

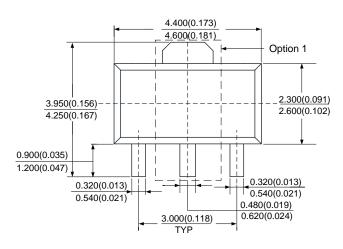
(1) Package Type: SOT-23-5

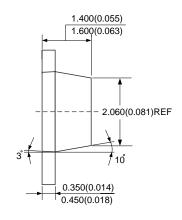


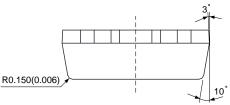


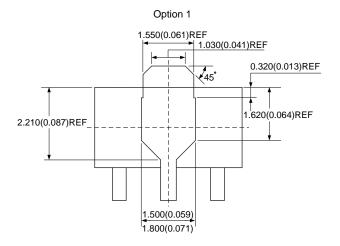
Package Outline Dimensions (Cont. All dimensions in mm(inch).)

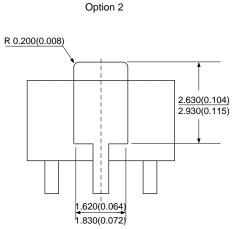
(2) Package Type: SOT-89







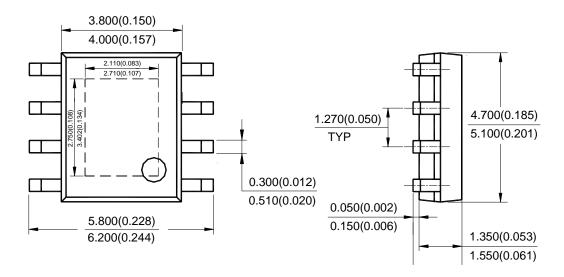


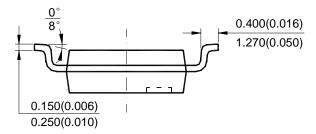




Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(3) Package Type: PSOP-8



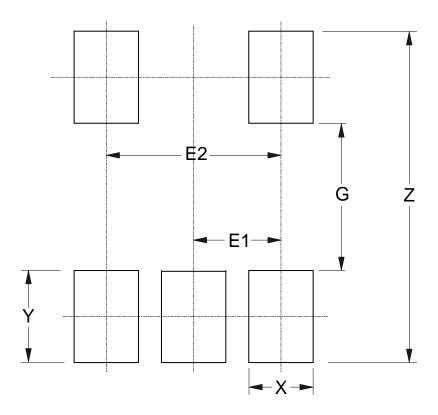


Note: Eject hole, oriented hole and mold mark is optional.



Suggested Pad Layout

(1) Package Type: SOT-23-5

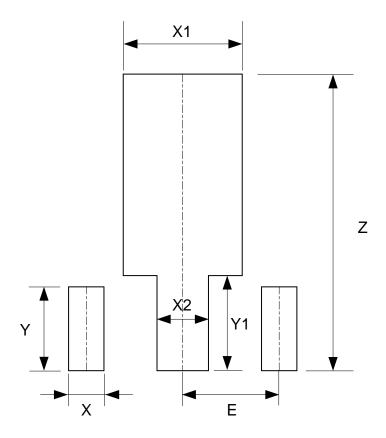


Dimensions	Z	G	X	Y	E1	E2
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075



Suggested Pad Layout (Cont.)

(2) Package Type: SOT-89

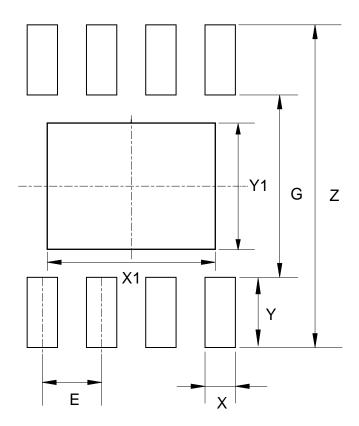


Dimensions	Z	X	X1	X2	Y	Y1	E
	(mm)/(inch)						
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059



Suggested Pad Layout (Cont.)

(3) Package Type: PSOP-8



Dimensions	Z	G	X	Y	X1	Y1	E
	(mm)/(inch)						
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	3.600/0.142	2.700/0.106	1.270/0.050



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